High-quality nanothick single-crystal Y$_2$O$_3$ films epitaxially grown on Si (111): Growth and structural characteristics


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I. INTRODUCTION

Heteroepitaxial growth of insulators on semiconductors has always been of great interest in science and of importance in technology. For example, epitaxial growth of insulators on Si may find applications in fabrication of silicon-on-insulator and three-dimensional Si integrated circuits. Additional application is found in the efforts of high-on-insulator and three-dimensional Si integrated circuits. For example, epitaxial growth of insulators from 2 to 10 nm in thickness is useful in the dielectric layers of high-power microwave devices or lasers with high carrier mobility,9,10 a very urgent technological issue. A subsequent single-crystalline growth of dielectric material may turn the technology of heteroepitaxial system for electronic devices.

Many attempts have been taken to grow epitaxial Y$_2$O$_3$ films on Si,1,6–8 due to a small lattice mismatch of ~2.4% between Si [2 × a(Si) = 1.086 nm] and cubic phase Y$_2$O$_3$ [(a(Y$_2$O$_3$) = 1.060 nm)]. Y$_2$O$_3$ (110) was found to epitaxially grow on Si (100) with two degenerate domains of an equal population.1,7 The degeneracy was removed with the employment of vicinal (001) Si substrates of 4° miscut along [1 $\bar{1}$ 0], resulting in the growth of mostly single-domain (110) oriented epitaxial films.1,7 For growing Y$_2$O$_3$ on Si (111),8 it has been difficult to achieve a good epitaxial Y$_2$O$_3$ (111) layer of a few nanometers thick on Si (111). For example, epitaxial Y$_2$O$_3$ films on Si (111) were prepared by the reaction of evaporated yttrium under an oxygen partial pressure (10$^{-6}$ torr) for a film thickness of ~75 nm.8 An oxidized Si surface [4° vicinal (111) orientation] with a SiO$_2$ layer 1.5 nm thick was needed to achieve better quality epitaxy while islandlike growth was found on a clean Si surface. In this paper, an excellent growth of nanotrich Y$_2$O$_3$ (111) has been achieved on Si (111) with an atomically smooth interface and a record-small full width at half maximum (FWHM) ~0.014° in rocking scans obtained in films of thickness less than 10 nm. The oxide films were deposited from electron-beam evaporation of a powder-packed Y$_2$O$_3$ target in ultrahigh vacuum (UHV). X-ray scattering and reflectivity using a synchrotron radiation source, and a high-resolution transmission electron microscopy (HRTEM) were used to study the Y$_2$O$_3$/Si (111) heteroepitaxial system for the dielectric layers from 2 to 10 nm in thickness.

II. EXPERIMENT

Si (111) wafers were cleaned by the Radio Corporation of America method, and hydrogen passivated by a buffered hydrofluoric acid solution, before being put into a multichamber molecular beam epitaxy/electron-beam evaporation UHV system.9 After being heated to 700 °C, the Si surface exhibited a conversion from a weak (1 $\times$ 1) to a bright (7 $\times$ 7) reconstructed reflection high-energy electron diffraction (RHEED) pattern with Kikuchi arcs [Fig. 1(a)], indicating a clean Si surface free of contaminations or native oxides.10 A thin Y$_2$O$_3$ film was then deposited on the reconstructed Si surface, with substrate temperature maintained at about
780 °C. A (1 × 1) oxide RHEED pattern [Fig. 1(b)] appeared right after the oxide deposition along with the reconstructed (7 × 7) of weaker intensity from the Si beneath, which disappeared after the oxide growth up to 0.3–0.4 nm. The (1 × 1) oxide RHEED pattern persisted until the appearance of a reconstructed (4 × 4) streaky RHEED pattern. The sharp bright (4 × 4) pattern, as shown in Fig. 1(c), was observed after the growth of the Y2O3 film ~3 nm thick, indicating attainment of a high-quality crystalline film with an atomically smooth surface. After deposition, the sample was capped with a thin layer of Si for protection, as the rare-earth oxide tends to absorb moisture with air exposure.11

HRTEM specimens were prepared with mechanical polishing, dimpling, and ion milling using a Gatan PIPS system operated at 4 kV. HRTEM images were taken using a field-emission microscopy (JEM-2100F) operated at 200 kV. For better understanding of the obtained TEM pictures, we have carried out a fast Fourier transform (FFT) analysis on digitally saved TEM images.

The synchrotron x-ray measurements were performed at wiggler beamline BL17B1 at the National Synchrotron Radiation Research Center, Hsinchu, Taiwan, and the detailed experimental procedure was described in Ref. 12. High-resolution x-ray measurements were carried out in single-crystal geometry. X-ray reflectivity measurements were performed to determine film thickness and surface/interfacial roughness.13,14 A hexagonal unit cell (h) was adapted by coordinate transformation from commonly used cubic unit cell to decouple the normal and in-plane components of momentum transfer in x-ray scattering measurements. In reciprocal space, the basis vectors are transformed in the following: (100)h=(422)/3, (010)h=(224)/3, and (001)h=(111)/3, where the momentum transfer in the direction normal to the interface is represented by a single index l.12

III. RESULTS AND DISCUSSION

X-ray diffraction (XRD) was used to analyze the phase and crystallographic orientation of Y2O3 layers deposited on Si (111). Figure 2 shows the radial scans along the Si (006)h crystal truncation rod (CTR) of two samples with different oxide thickness (3.6 and 7.2 nm), where the x axis is in the units of reciprocal lattice (rlu) of silicon in the hexagonal frame. The intense sharp peaks centered at 3 and 6 rlu are the Si (003)l and (006)l, i.e., (222) and (444) reflections, respectively. The two strong broad peaks, centered at ~3.11 and ~6.15 rlu, are attributed to the (006)h and (0012)h, i.e., (222) and (444) of Y2O3. Their corresponding interplanar spacing is close to d222 and d444 of cubic phase of Y2O3. Only the Y2O3 (000)l reflections with l equal to 6 and 12 were observed on the radial scans along the surface normal, indicating that the oxide films are (111) oriented with a bixbyte structure. The presence of periodic Pendellosung fringes which originate from the interference between the top and buried interfaces reveals the atomically smooth interfaces and the high crystalline quality of the deposited layer. Estimated from the FWHM of Y2O3 (0012)h reflections for different oxide thickness, the coherence length along the growth direction is always comparable to the film thickness, implying that the structural coherence extends over the whole film thickness.

To further examine the crystalline quality of the oxide films, we also performed ω-rocking scan on the samples. A very narrow peak with a FWHM of 0.017° for a 3.6 nm thick film [slightly wider than the 0.008° FWHM of the nearby Si (006)l reflection] was measured; an even smaller peak width ~0.014° (as shown in the insert of Fig. 2) was obtained for thicker films. Such narrow rocking curves reveal the small mosaicity and highly perfect crystalline structure of the grown films. With increasing layer thickness, e.g., 7.2 nm, the film structure gradually relaxes through the generation of dislocation, leading to the appearance of an additional broad component in the rocking curve. With thickness further increasing to 9.5 nm, misfit dislocations and their induced strain fields would be gradually buried below and the broad component of the rocking curves gradually becomes narrower.

The strain state of the films was determined from the lattice spacing along normal and lateral directions (not shown).
Over the range of film thickness investigated, a monotonic decrease/increase of normal/lateral lattice spacing was observed. For the thinnest film studied, 1.6 nm thick, the measured in-plane strain is \( \sim 1.5\% \), significantly less than the 2.5\% expected for a fully strained layer. Up to 9.5 nm thick, the lattice of Y\(_2\)O\(_3\) films is not fully relaxed, and a lateral strain \( \sim 0.4\% \) still remains. X-ray scattering results indicate that for Y\(_2\)O\(_3\) films of thickness less than 10 nm, the lattice changes from a highly strained stage to a nearly fully relaxed one with increasing film thickness.

Azimuthal scans (\( \phi \) scan) across Y\(_2\)O\(_3\) \( \{208\}_h \) and \( \{204\}_h \), i.e., \( \{440\} \) and \( \{400\} \), respectively, were performed to examine the relative in-plane orientation and the ratio between two types of rotational domains. The \( \phi \) scans of a 9.5 nm thick Y\(_2\)O\(_3\) film are shown in Fig. 3 as an example. The broad peaks that appeared in the Y\(_2\)O\(_3\) \( \{400\} \) \( \phi \) scan came from the tail of Si \( \{220\} \) CTRs; the 60° offset between these two sets of peaks reveals that the [110] in-plane axis of the Y\(_2\)O\(_3\) film is rotated 60° from that of the Si substrate, known as the B-type (111) oriented domain with Y\(_2\)O\(_3\) [21\( \bar{1} \)] \| Si [112]. Furthermore, two sets of sharp peaks with nearly equal peak width were observed in the Y\(_2\)O\(_3\) \( \{400\} \) \( \phi \) scan. The stronger set is the B-type domain, having the same origin as the sharp peaks in the \( \{440\} \) \( \phi \) scan. Because nearby Si \( \{200\} \) peaks are forbidden reflections and extremely weak, we can ensure that the set of weaker peaks originates from a second Y\(_2\)O\(_3\) domain with its in-plane axes aligned with those of the Si substrate, the A-type domain with Y\(_2\)O\(_3\) [21\( \bar{1} \)] \| Si [21\( \bar{1} \)]. The ratio between the dominant B-type domain and the minor A-type domain grows with film thickness, with the fraction of B-type domain exceeding 90\% as the film thickness \( > 5 \) nm.

A representative cross-sectional HRTEM image of the crystalline Y\(_2\)O\(_3\) film 7.2 nm thick along the Si [112] projection is shown in Fig. 4(a). It reveals a sharp Y\(_2\)O\(_3\)/Si interface, which was magnified and displayed in Fig. 4(b). To analyze the interfacial structure in more detail, a masking step and an inverse fast Fourier transform (IFFT) were applied to the FFT results. That is, a specific diffraction pattern in reciprocal space was chosen by the spot-shaped mask pattern and then IFFT was performed. Figure 4(c) shows the Fourier filtered image of the area enclosed by a rectangle in Fig. 4(b). Misfit dislocations were marked “T” at the interface. The location of an edge component of misfit dislocation is clearly shown at the interface. These linear defects provide a relaxation mechanism for the strained lattice. It is well known that the presence of misfit dislocations is a characteristic structural feature of epitaxial thin films grown on dissimilar substrates with a large lattice mismatch. With a lattice mismatch of 2.4\% between Y\(_2\)O\(_3\) and Si, the 7.2 nm oxide thickness exceeds the critical thickness and consequently strain has been partially relaxed. This result is consistent with the lattice relaxation observed in the XRD measurements.

**IV. CONCLUSIONS**

Excellent crystalline quality of nanotick single-crystal Y\(_2\)O\(_3\) films on Si (111) has been achieved. The oxide/Si heterostructure has atomically smooth interfaces, as studied using high-resolution x-ray diffraction with synchrotron radiation and high-resolution transmission electron microscopy. Two rotational domains coexist in the Y\(_2\)O\(_3\) films, with the population of the predominant B-type domain increasing with thickness.

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6S. Guha, E. Cartier, M. A. Gribelyuk, N. A. Bojarczuk, and M. C. Copel, Appl. Phys. Lett. 77, 2710 (2000) and the references therein.